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# Energy Profiling of FPGA-based PHY-layer Building Blocks Encountered in Modern Wireless Communication Systems

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**Abstract**—Characterizing the energy cost of different physical (PHY) layer building blocks is becoming increasingly important in modern cellular-based communications, considering the cross sector requirements for performance enhancements and energy savings. This paper presents energy profiling metrics of different PHY-layer FPGA implementations encountered in modern wireless communication systems. The results give an insight of the distribution of the consumed energy in different baseband building blocks or configurations before and after applying power optimizations in the FPGA design and implementation.

## I. INTRODUCTION

The energy cost of the different functional components comprising small cell base stations (BSs) has been redistributed in respect to that of macro cell BSs. As a consequence, the energy consumption of the baseband signal processing dominates the energy-budget of small-cell BSs [12]. On top of that, the PHY-layer in next generation small cell BSs and wireless backhaul nodes will have to support wider signal bandwidths (BWs), smart antenna techniques and coexistence of different radio interfaces. Such technology enhancements are expected to have an incremental impact on the consumed energy at baseband.

Thus, the energy profiling of the PHY-layer building blocks becomes an increasingly important topic during the design and implementation stages, especially when tight power-budgets need to be met. The baseband processing load of small-cell BSs or user equipment (UE) is either assigned to application specific integrated circuits (ASICs), system-on-chip (SoC) ICs or field programmable gate arrays (FPGAs). Characterizing the power consumption of PHY-layer building blocks could enable the energy-aware hardware-software partitioning in SoC baseband processors. Moreover, the energy profiling metrics could be used to enforce scheduling decisions at the medium access (MAC) layer.

This paper presents detailed results of the estimated energy cost in different PHY-layer configurations of the 3GPP LTE (release 9) and IEEE 802.16e standards, when targeting implementations [1], [2], [3] at different FPGA devices. The power footprint of single and multi-antenna schemes is evaluated for a downlink (DL) transmitter and receiver. Power

savings are achieved by employing low-level digital design techniques. An insight is also offered to the individual contribution of different FPGA building blocks in the estimated power consumption, before and after applying power optimizations features in the FPGA design software.

## II. RELATED RESEARCH

The power profiling in FPGA devices is a subject that is strongly affected by the specific performance and input/output (I/O) requirements of the targeted end-application. The work in [4] is an early example of algorithms that predict net activity and interconnect capacitance related to the dynamic power consumption. The authors in [5] focus on FPGA dynamic power minimization through placement and routing constraints. Similarly, the authors in [6] report significant savings in the consumption of FPGA dynamic power by applying edge alignment and glitch filtering. Another example is presented in [7] where the authors conduct real-life measurements and propose architecture-level power-reduction techniques for an image processing algorithm. The paper in [8] investigates the effects of different optimization schemes on FPGA power consumption, when implementing eight security algorithms. Finally, in [9], the authors developed a current consumption measurement approach for FPGA-based embedded systems.

The contribution of this paper is the analytic assessment of the energy-cost figures of different PHY-layer implementations, configurations and FPGA devices, when applying different coding styles and power optimization techniques both at design and at implementation level.

## III. BACKGROUND AND METHODOLOGY

Although certain generic power-aware techniques or guidelines [10], [11] can be applied either during the design of the register transfer level (RTL) code, or during the implementation targeting a specific FPGA device, the energy consumption remains a topic that is tightly coupled with: **i)** the device technology (e.g., integration scale, silicon fabrication process, operating voltages), **ii)** the specific requirements of the end-application (i.e., baseband signal BW, embedded

memory blocks, I/Os, clock domains and sample rates) **iii**) the structure of the digital design (programming style, hierarchical modularity), **iv**) the implementation-specific factors (e.g., placement and timing constraints) and **v**) the ability to employ system-wide power-saving techniques (e.g., partial reconfiguration, shut-down, suspend and hibernation modes of operation). The total energy consumption in FPGA devices is defined as the sum of the device static power, the design static power and the design dynamic power:

$$P_{\text{total}} = P_{\text{device static}} + P_{\text{design static}} + P_{\text{design dynamic}}$$

where  $P_{\text{device static}}$  is the power required for the device to operate and be available for programming (i.e., mostly related to leakage in the transistors that hold the device configuration),  $P_{\text{design static}}$  is the additional power required when the device is configured with an application and no activity occurs (i.e., static current from I/O terminations, clock managers, and other circuits which need power regardless of design activity) and  $P_{\text{design dynamic}}$  is the additional power related to the design activity (this power varies over time and is related to the logic and routing resources employed). The combination of  $P_{\text{device static}} + P_{\text{design static}}$  is also denoted as  $P_{\text{quiescent}}$  or simply  $P_{\text{static}}$ .

The energy footprint of different PHY-layer implementations and configurations was calculated using the Xilinx power analyzer (XPA) software, which is able to estimate the power drawn from the different functional components comprising FPGA devices. The use of additional configuration files detailing the signal-toggle activity, enabled more realistic estimations [10]. The XPA design and test flow is divided in the following steps:

- The RTL design of each PHY-layer configuration was implemented targeting a specific FPGA device. The default implementation options for synthesis, mapping and placing and routing (PAR) were selected (without power optimizations). In specific cases, the implementation was repeated in separate projects, applying the power optimization options available at the Xilinx ISE software.
- Post-PAR timing simulations were launched for each FPGA implementation case. In order to respect the guidelines given in [10], the simulations made use of realistic data test-vectors that were captured in the hardware setup described in [1], [2] and [3]. Taking into account that the post-PAR timing simulations are highly bit-intensive and time-consuming, we have simulated approximately 20ms of signals' activity (i.e., two complete WiMAX or LTE radio frames). The post-PAR simulations made use of two files generated by the PAR process: i) a hardware description language (HDL) file with a simulation model that takes into account the targeted FPGA device primitives and ii) a file containing true timing delay information of the design (standard delay format file).
- The XPA tool was configured with standard environmental settings (e.g., 25° C) and a specific FPGA device package in each case (i.e., commercial version with average speed-grade classification). Three files, produced in previous steps, were loaded to the XPA software for each of the

FPGA implementation projects, in order to achieve accurate power estimation results: i) placed and routed design database (NCD) file that contains all logic configuration and routing information, ii) physical constraints (PCF) file that contains settings for all of the logic and I/Os in the design and specific nets activity (e.g., clock distribution networks) and iii) post-PAR simulation results (VCD) file, which matched nets in the design database with names in the simulation results netlist. For all nets matched, XPA applied switching activity and static probability to calculate the design power. In this way, the XPA assessed realistic activity for the matched nodes.

#### IV. RESULTS AND DISCUSSION

This section includes the energy profiling results for different PHY-layer implementations and configurations of the 3GPP LTE (release 9) and IEEE 802.16e (mobile WiMAX) standards. Since both of them use the orthogonal frequency division multiplexing (OFDM) scheme, they exhibit a high degree of functional similarity. As shown in Table I, the implemented specifications for the two standards have fixed values for most of their characteristics, with the WiMAX one supporting certain additional options.

TABLE I: THE KEY SPECIFICATIONS OF THE LTE AND WIMAX STANDARDS

Specifications		LTE	Mobile WiMAX
Antenna schemes	open-loop	SISO	SISO, 1x2 SIMO, 2x2 MIMO,
	closed-loop	-	MIMO (2x2 with antenna selection)
Transmitter / Receiver		DL (FDD)	DL (TDD)
Signal BW (MHz)		20	20
Sampling frequency (MHz)		30.72	22.4
Cyclic prefix (samples)		512	512
Modulation		QPSK	QPSK, (16-256) QAM
FFT size		2048	2048
Subcarriers per OFDM symbol (active + null)		1200+ 848	PUSC: 1440 + 368 AMC: 1536 + 320

The implementations described in [1], [2] and [3] were originally partitioned in a number of Virtex-4 devices (see Table II for more information). However, in order to show the impact of the different FPGA device technologies on the occupied FPGA resources and the consumed power, we have also targeted modern Xilinx FPGA families. All FPGA implementations used a single I/O interface that connects the transmitter's and receiver's PHY-layer to digital-to-analog and analog-to-digital converters. The additional I/O connections, logic blocks and clock domains that might be required when the HDL design of the PHY-layer is integrated as user-logic within the firmware of a specific FPGA board were not taken into account (e.g., connections with external memory controllers, peripherals, on-chip gigabit transceivers and debugging logic). It is important to note that the inclusion of such components is FPGA-device and FPGA-board specific and may considerably increase the static and the dynamic power consumption. The different power consumption benchmarking metrics were grouped in three case studies that focus on different comparison aspects.

### A. Case study one: LTE versus mobile WiMAX

A single input single output (SISO) DL transmitter and receiver based on the LTE and WiMAX specifications were implemented, by utilizing a custom HDL coding approach. The implementation of both systems was partitioned in three Virtex-4 FPGA devices (XC4VLX160) and was carried out with the Xilinx ISE 9.2 software (Table II shows FPGA utilization metrics). Although the implemented specifications for the two standards feature a close match, certain variations, such as the baseband sampling frequency had an impact on the estimated power consumption. The WiMAX implementation features three different permutation schemes and other memory operations related to the standard, which do not exist in the LTE implementation. This is reflected to the high usage of RAMB16s in the WiMAX implementation (see Table II). The reverse applies for the DSP48 slices due to the presence of an interference-detection mechanism in the LTE receiver requiring extra digital filters (not present in the WiMAX one).

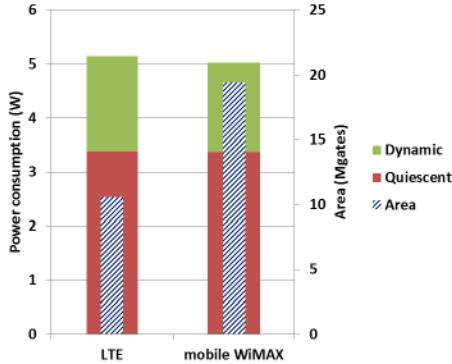


Fig. 1. Estimated power consumption versus required FPGA area (gate-count equivalent) for the single-antenna LTE and WiMAX systems.

Moreover, in order to demonstrate the benefits of energy-wise HDL coding techniques, different programming styles were employed in the otherwise quite similar WiMAX and LTE PHY-layer implementations. For instance clock-gating [11] and data-gating techniques were applied to the WiMAX implementation. Moreover, when compared to the LTE implementation, the WiMAX one features a highly modular HDL design, with pipelining and signal-registering techniques applied across a structured HDL hierarchy. As it can be observed in Fig. 1, although the gate-count equivalent in the WiMAX implementation is higher compared to the LTE one (i.e., due to the additional processing blocks), both the estimated  $P_{\text{quiescent}}$  and  $P_{\text{dynamic}}$  of the WiMAX implementation are lower. Hence, the applied HDL coding techniques allowed achieving extra processing features at a lower energy cost. Yet, the total power consumption is high due the use of multiple FPGA devices and also due to the device technology.

### B. Case study two: multi-antenna configurations

On top of the SISO open-loop (OL) configuration, the WiMAX implementation includes two additional OL multi-antenna schemes [2]. These are i) a 1x2 single input multiple output (SIMO) implementation that features a maximum ratio combining DL receiver and ii) a 2x2 multiple input multiple

output (MIMO) implementation, which uses the matrix-A transmit diversity scheme defined in the standard. Finally, a more advanced 2x2 MIMO scheme features an implementation of a closed-loop (CL) communication system [3], where the transmitter applies antenna-selection based on channel state information (i.e., provided by the receiver). The HDL implementation of the mentioned systems was partitioned in multiple Virtex-4 FPGA devices (XC4VLX160).

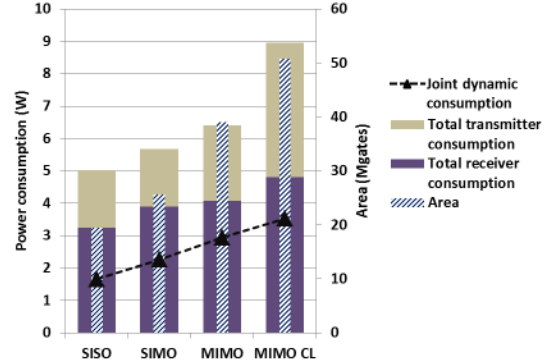


Fig. 2. Estimated power consumption versus required FPGA area (gate-count) of different WiMAX multi-antenna schemes.

TABLE III: FPGA UTILIZATION METRICS FOR THE LTE AND WIMAX SYSTEMS

Antenna Scheme	Slices	DSP48s	RAMB16s	#FPGAs
LTE				
SISO	56289	222	135	3
Mobile WiMAX				
SISO OL	52373	167	271	3
1x2 SIMO OL	104220	187	353	3
2x2 MIMO OL	126751	226	533	3
2x2 MIMO CL	131460	302	715	5

As it may be observed in Fig 2, the area requirements (gate-count equivalent) increase almost linearly in respect to the baseband complexity of the multi-antenna schemes. The same applies in the case of the estimated joint dynamic power of the transmitter and receiver. The FPGA utilization metrics shown in Table II are in accordance to the expected processing complexity of each system. Similarly, the estimated total power of the transmitter and receiver in each case, matches with the computational complexity of each implementation. For instance, the transmitter in the CL system is expected to be more processing demanding from its OL counterparts, a fact that is confirmed both from the FPGA area metrics and its total estimated power.

### C. Case study three: LTE PHY-layer in modern FPGAs

A useful comparison of the energy-cost of the LTE PHY-layer implementation was made feasible by targeting the Xilinx Virtex-6, Virtex-7 and Zynq SoC devices. Each of the selected devices could fit the entire DL transmitter and receiver. Different instances of the Xilinx ISE 14.7 software were used to implement the LTE PHY-layer for each of the targeted FPGA devices. The default synthesis, mapping and PAR options were initially selected; then a separate ISE project was created for each device applying the ISE power-optimization options for the mentioned stages (the FPGA utilization metrics are shown in Table III). The XPA tool

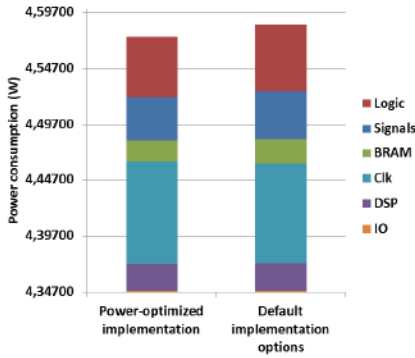


Fig. 3. Estimated power consumption of the LTE PHY-layer implementation (XC6VX475T).

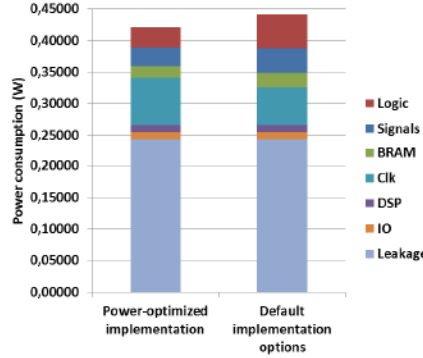


Fig. 4. Estimated power consumption of the LTE PHY-layer implementation (XC7VX485T).

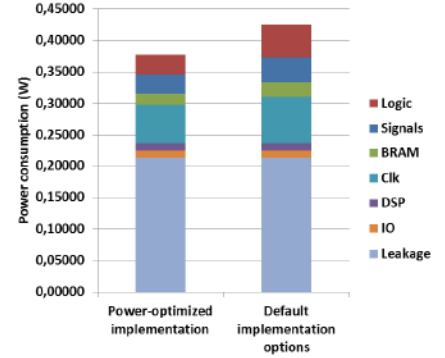


Fig. 5. Estimated power consumption of the LTE PHY-layer implementation (XC7Z045).

provided the estimated static and dynamic power consumption with and without power optimizations for each of the selected devices.

As it may be observed in Fig. 3, Fig.4 and Fig. 5 the power optimization options of the ISE software have mainly reduced the consumed power in logic, signals and BRAMs, whereas they do not seem to have a significant effect to the power drawn by DSP slices and I/Os. Also, depending on the implementation strategy (i.e., speed versus area), the power optimizations might result in a relative increase of the power drawn by the clocking resources. Finally, Fig. 6 shows that the dynamic power of the Virtex-7 device features a 28.8% reduction compared to the Virtex-6 one; similarly, the Zynq device achieves a 7.3% reduction of the dynamic power, compared to the Virtex-7 one.

TABLE III: THE POWER-OPTIMIZED LTE IMPLEMENTATION

FPGA device	Slices	DSP48E1	RAMB18E1	RAMB36E1
XC6VX475T	9680	271	101	4
XC7VX485T	11727	271	102	3
XC7Z045	10293	271	102	3

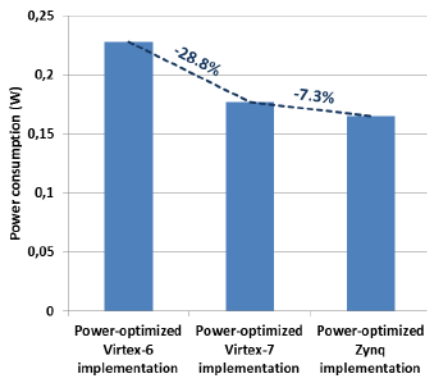


Fig. 6. Estimated dynamic power consumption in different FPGA devices.

## V. CONCLUSION

The benefits of adopting power-reduction techniques during the RTL design stage were demonstrated in this paper. Benchmarking results for different multi-antenna schemes were also provided. Additionally, the effects of the power optimizations applied during the FPGA implementation flow were analyzed for different devices. The current work can be extended by conducting run-time FPGA power consumption

measurements. The latter would enable a more versatile characterization of the LTE/WiMAX PHY-layer energy cost.

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